

Electronic Acknowledgement Receipt

EFS ID:	3923943
Application Number:	10595303
International Application Number:	
Confirmation Number:	7114
Title of Invention:	Method and Device For Secure, Insulated and Electrically Conductive Assembling Of Treated Semiconductor Wafers
First Named Inventor/Applicant Name:	Roy Knechtel
Customer Number:	21967
Filer:	Jeff Vockrodt/Marcus Cunningham
Filer Authorized By:	Jeff Vockrodt
Attorney Docket Number:	60291.000048
Receipt Date:	11-SEP-2008
Filing Date:	19-MAY-2006
Time Stamp:	11:15:10
Application Type:	U.S. National Stage under 35 USC 371

Payment information:

Submitted with Payment	no
------------------------	----

File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)
1		IDS.PDF	179201 b13bb46062ffcf66dcd923be3e9ecf92866ca	yes	4

Multipart Description/PDF files in .zip description							
Document Description			Start	End			
Information Disclosure Statement Letter			1	2			
Information Disclosure Statement (IDS) Filed (SB/08)			3	4			
Warnings:							
Information:							
2	Foreign Reference	GBpatapp.PDF	432339 1a703ee10ff16146e5d7f332fc094d1 089	no	16		
Warnings:							
Information:							
3	Foreign Reference	EURpatapp.PDF	357838 d0739ca0d23842d96cc3b9eaf9e0e60d 0894	no	7		
Warnings:							
Information:							
4	Foreign Reference	DE19616014.PDF	628903 aeb9451d17987ac7aba1ca946748fbfb98 096	no	7		
Warnings:							
Information:							
5	Foreign Reference	DE10141753.PDF	505480 30bc93aa83ff11cc077184d27aa16879e1e4 a59c	no	5		
Warnings:							
Information:							
6	Foreign Reference	DE4006108.PDF	528227 066377c5d465fa1d1bc99818a1b599a157a ca26	no	7		
Warnings:							
Information:							
7	Foreign Reference	DE3837300.PDF	461242 811544bfa0937798c929cbda1320cc5ab 488918	no	5		
Warnings:							
Information:							
8	NPL Documents	ISR.PDF	112208 c77a6015298676072834c78bd467250b73a 3bb80	no	3		
Warnings:							
Information:							

9	NPL Documents	Jin.PDF	383500 cdd8567fb47fbef8-8ff2333ac21b9af7 c13da	no	6
---	---------------	---------	--	----	---

Warnings:**Information:**

10	NPL Documents	Kadar.PDF	1242359 10e99fb19380aa164c0f053003cf7753acc54 e1b	no	16
----	---------------	-----------	---	----	----

Warnings:**Information:**

11	Fee Worksheet (PTO-06)	fee-info.pdf	30403 14620y86ab4d548402ee4880/02156fe34 5376	no	2
----	------------------------	--------------	---	----	---

Warnings:**Information:**

Total Files Size (in bytes):	4861700
------------------------------	---------

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.